TE Internal #: 2-2338495-3

OSFP, Cage Assembly, Cable-to-Board, 1 x 4, Through Hole - Press-

Fit Mount, Printed Circuit Board, Included Lightpipe, Internal

/External EMI Springs

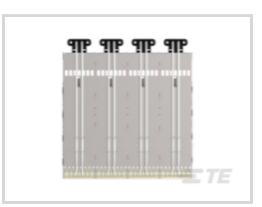
View on TE.com >



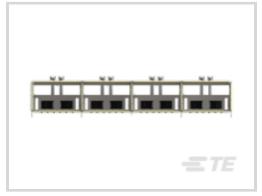
Connectors > Pluggable IO Connectors & Cages > OSFP > OSFP Cage Assembly: EMI Springs











Pluggable I/O Product Type: Cage Assembly

Connector System: Cable-to-Board
Port Matrix Configuration: 1 x 4

PCB Mounting Style: Through Hole - Press-Fit

Sealable: No

All OSFP Cage Assembly: EMI Springs (11)

## Features

## **Product Type Features**

Froduct Type reatures	
Form Factor	OSFP
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	1 x 4
Mechanical Attachment	
PCB Mounting Style	Through Hole - Press-Fit
Usage Conditions	

-55 – 85 °C[-67 – 185 °F]

Operating Temperature Range



Included Lightpipe	Yes
EMI Containment Feature Type	Internal/External EMI Springs

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



## Customers Also Bought

09/18/2023 03:19AM | Page 2

















#### **Documents**

#### **Product Drawings**

CAGE ASSEMBLY, 2 LP PER PORT, 1X4, OSFP

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2-2338495-3\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-2338495-3\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-2338495-3\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### Datasheets & Catalog Pages

OSFP Cages, Connectors, and Cable Assemblies (English)

English

### **Product Environmental Compliance**

**Product Compliance** 

English

**Product Compliance** 

English

OSFP, Cage Assembly, Cable-to-Board, 1 x 4, Through Hole - Press-Fit Mount, Printed Circuit Board, Included Lightpipe, Internal/External EMI Springs

